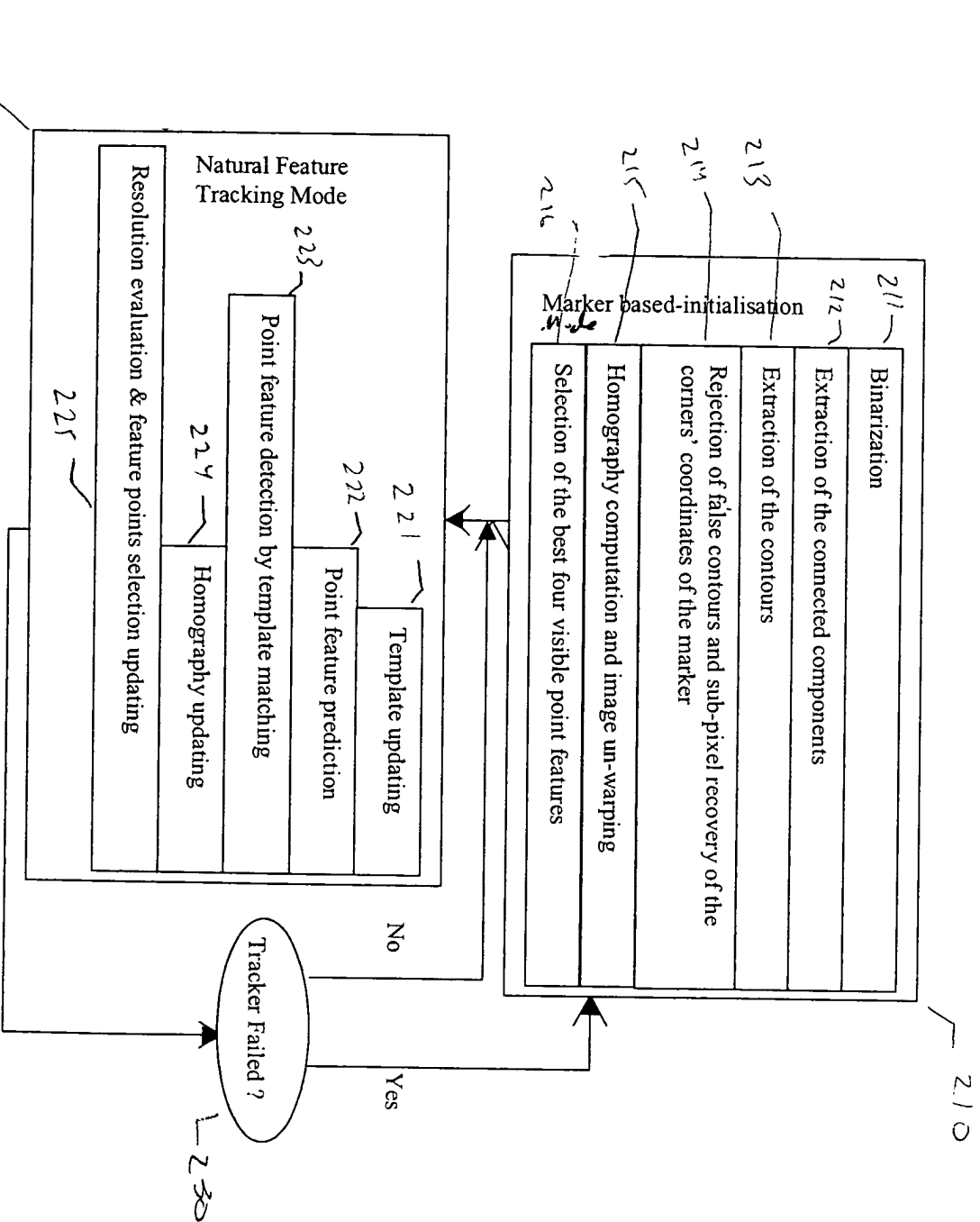




FIG. 1



**FIG. 2**

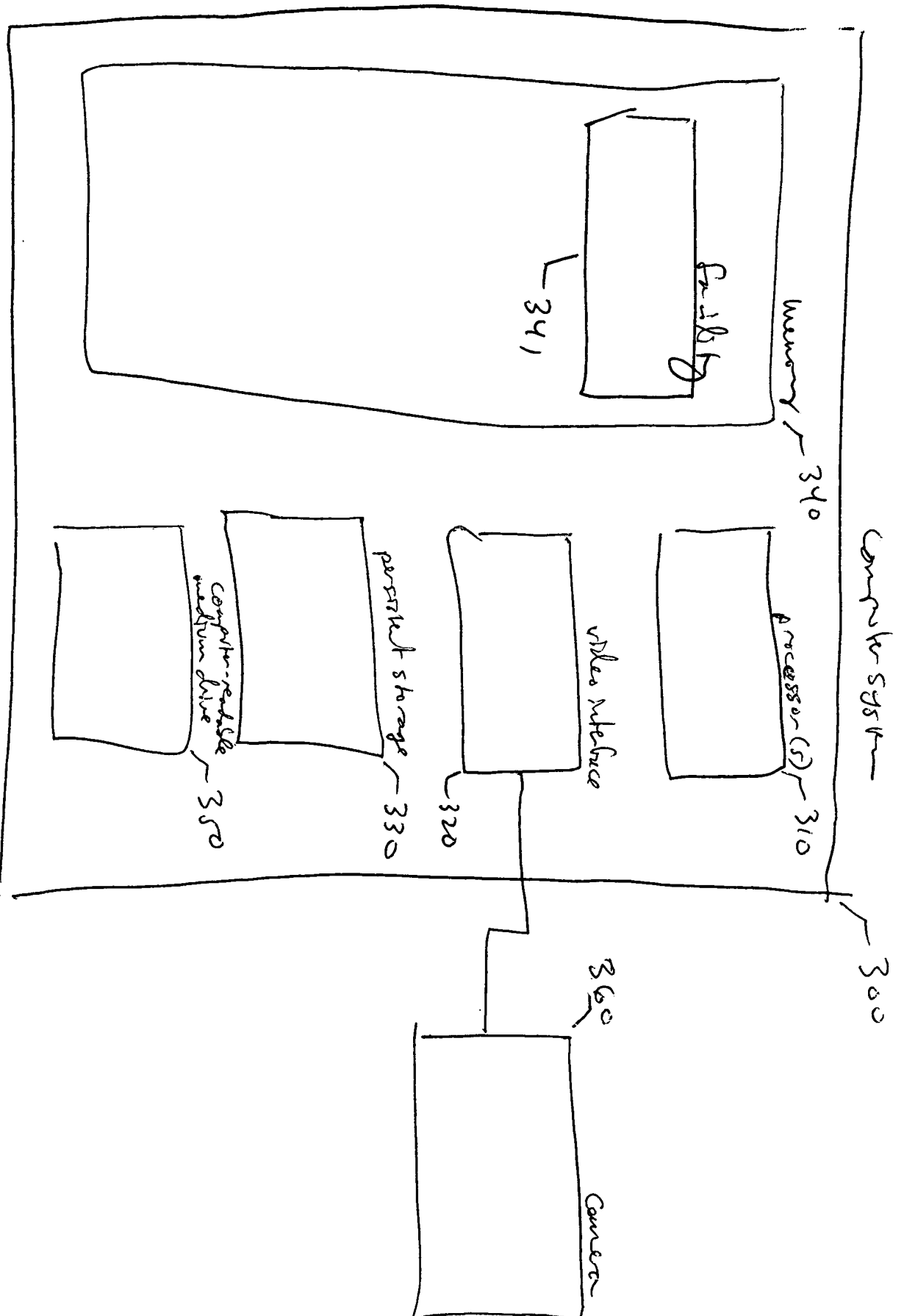


FIGURE 3.

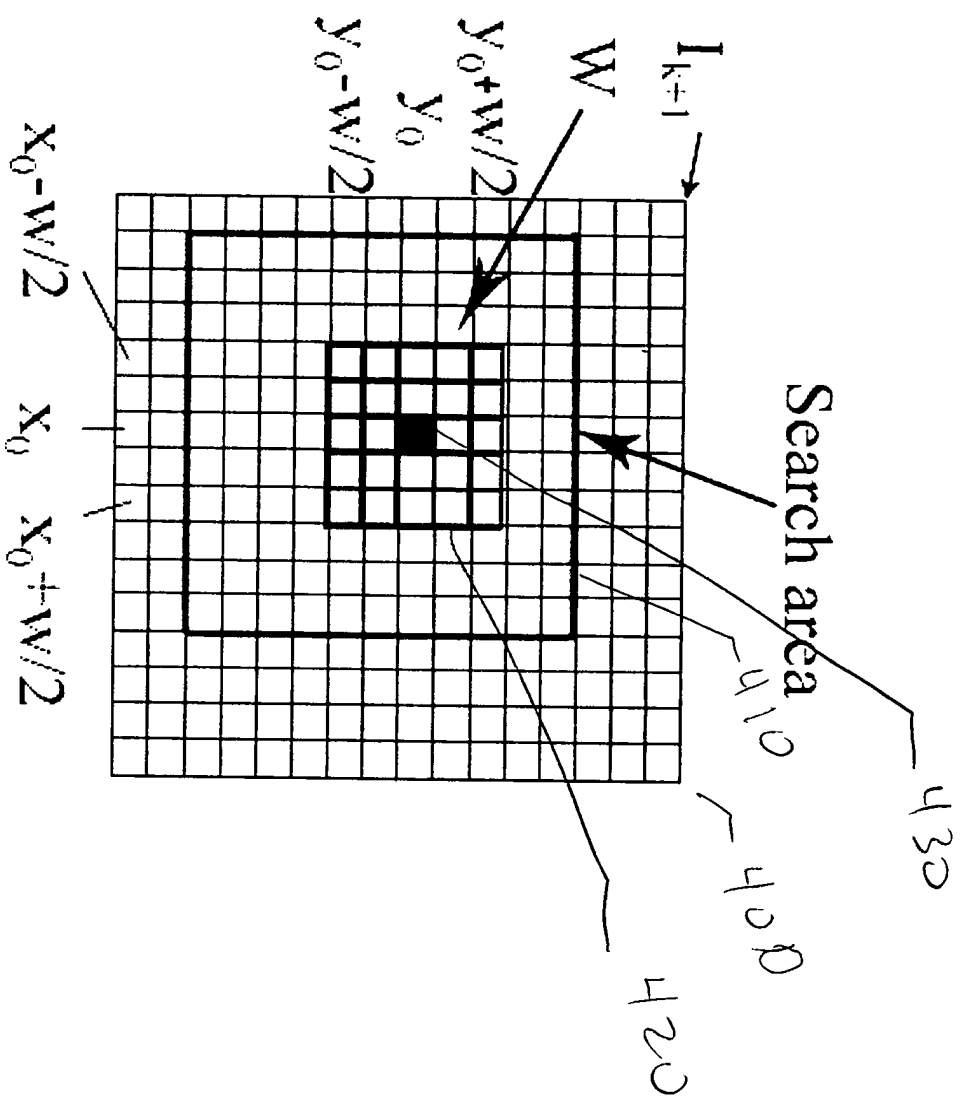
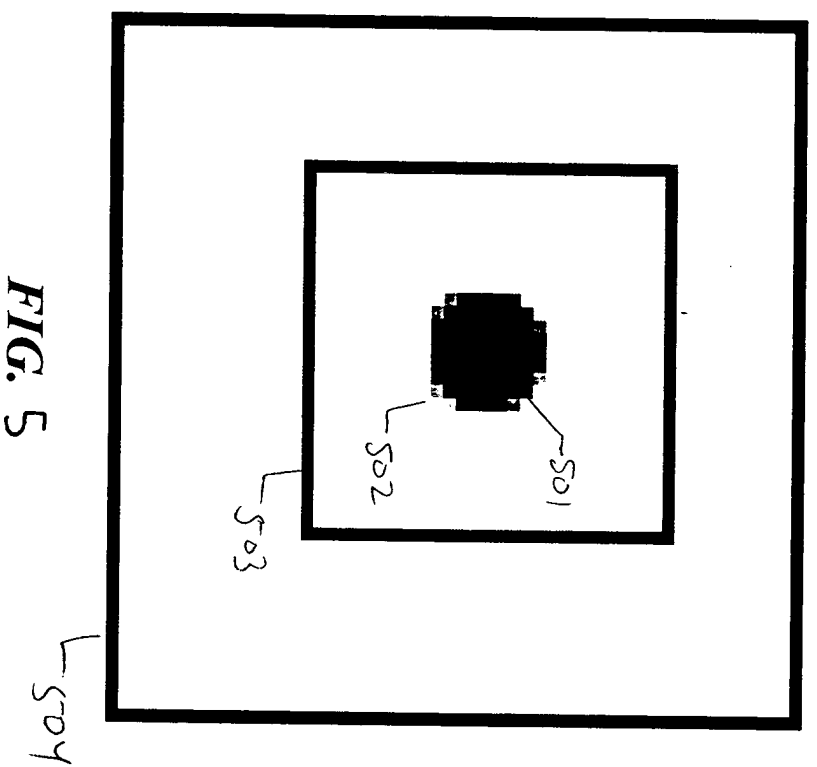


FIG. 4



**FIG. 5**

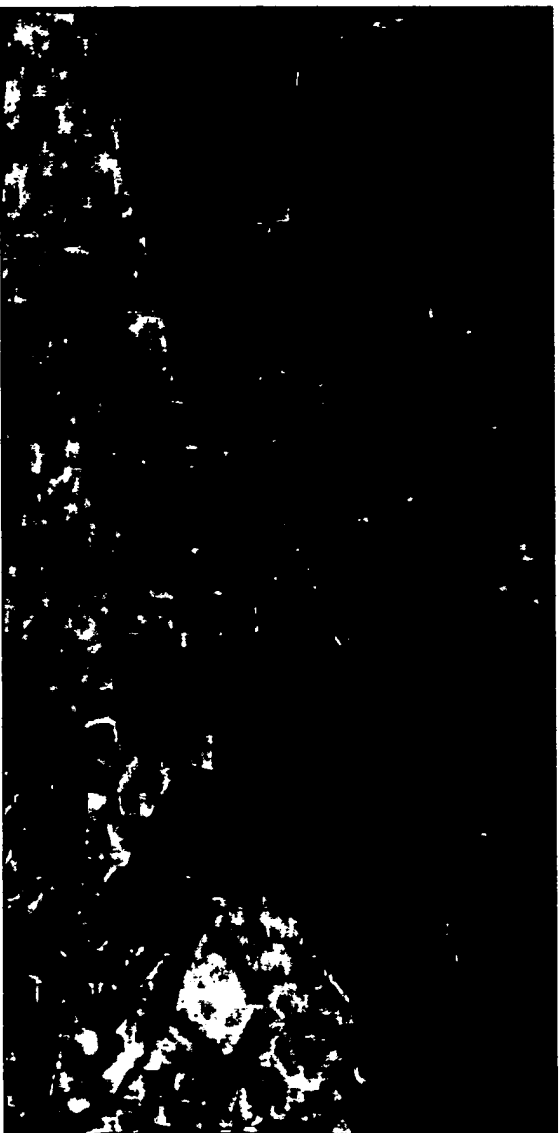


FIG 6A

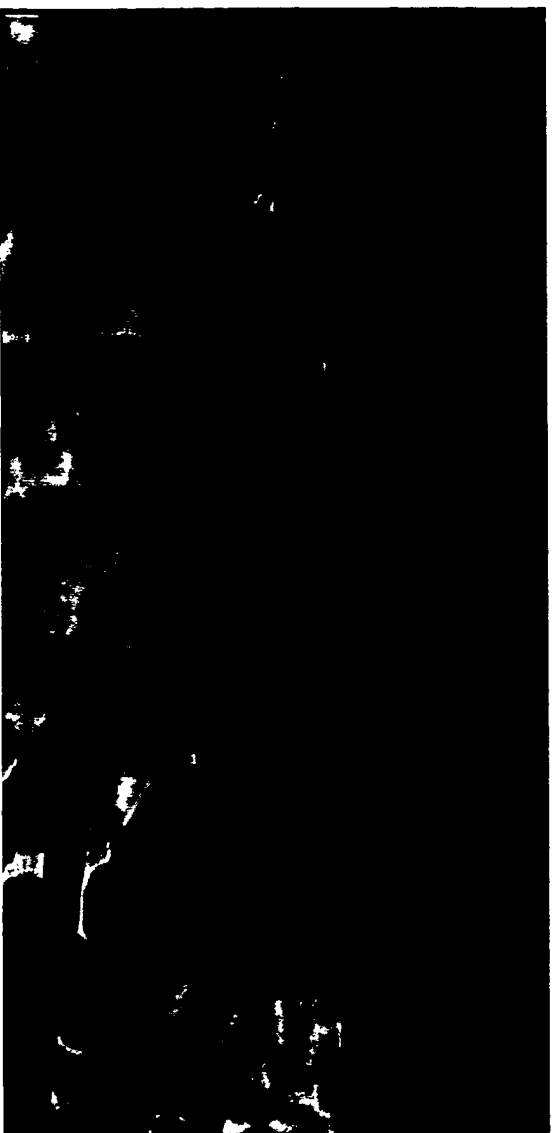


FIG 6B



FIG. 7

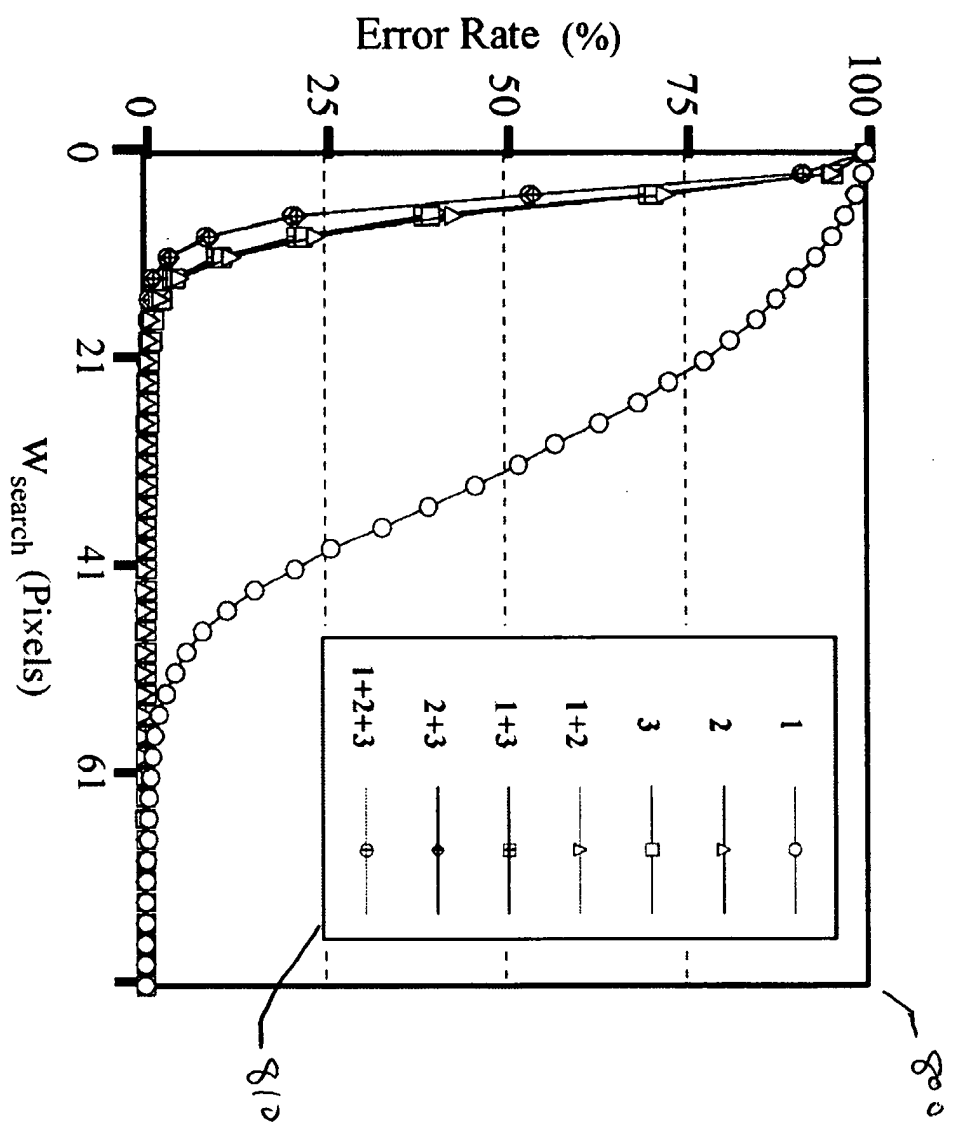


FIG. 8



FIG 9A

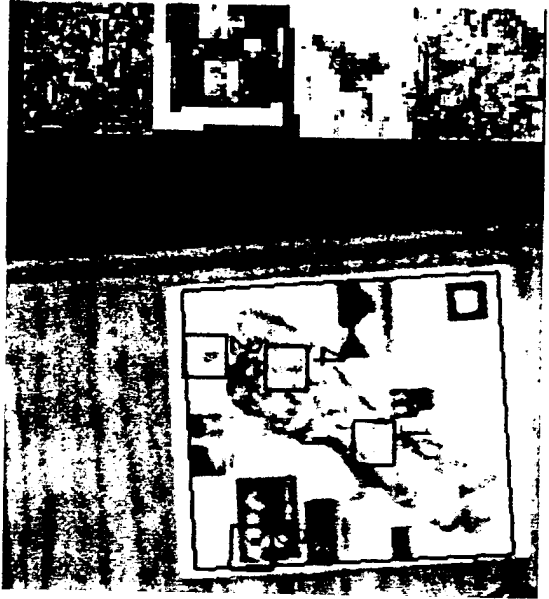


FIG 9C

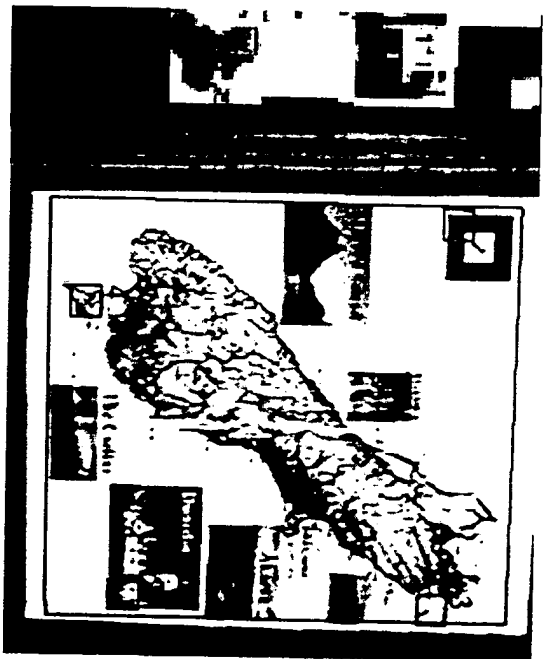
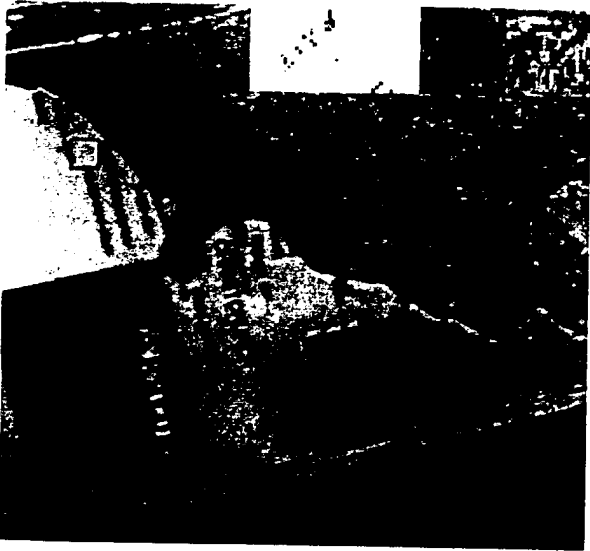


FIG 9B

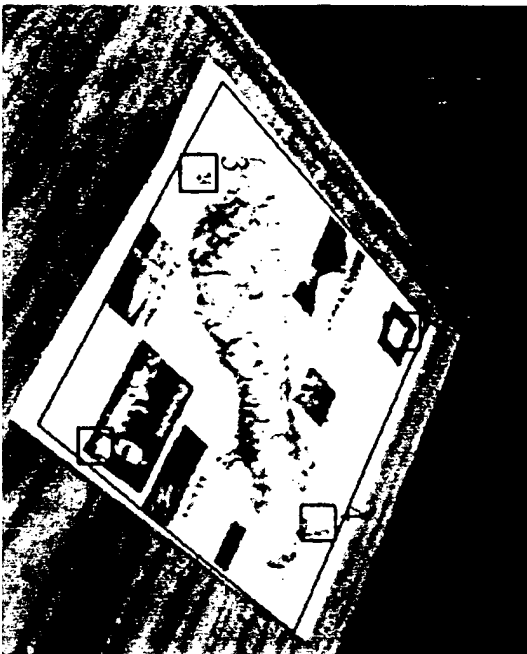


FIG 10A

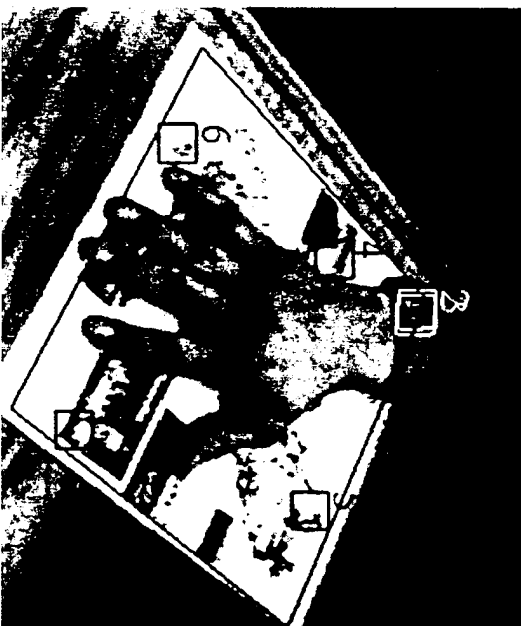


FIG 10B

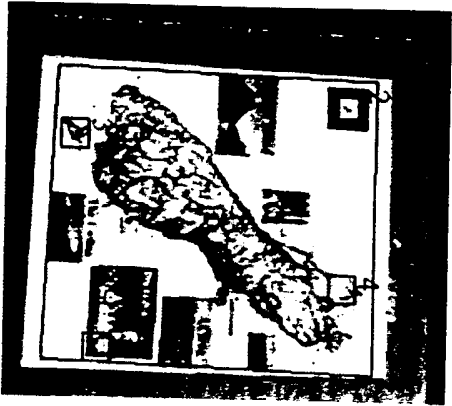


FIG 11A



FIG 11C



FIG 11B



FIG 11D

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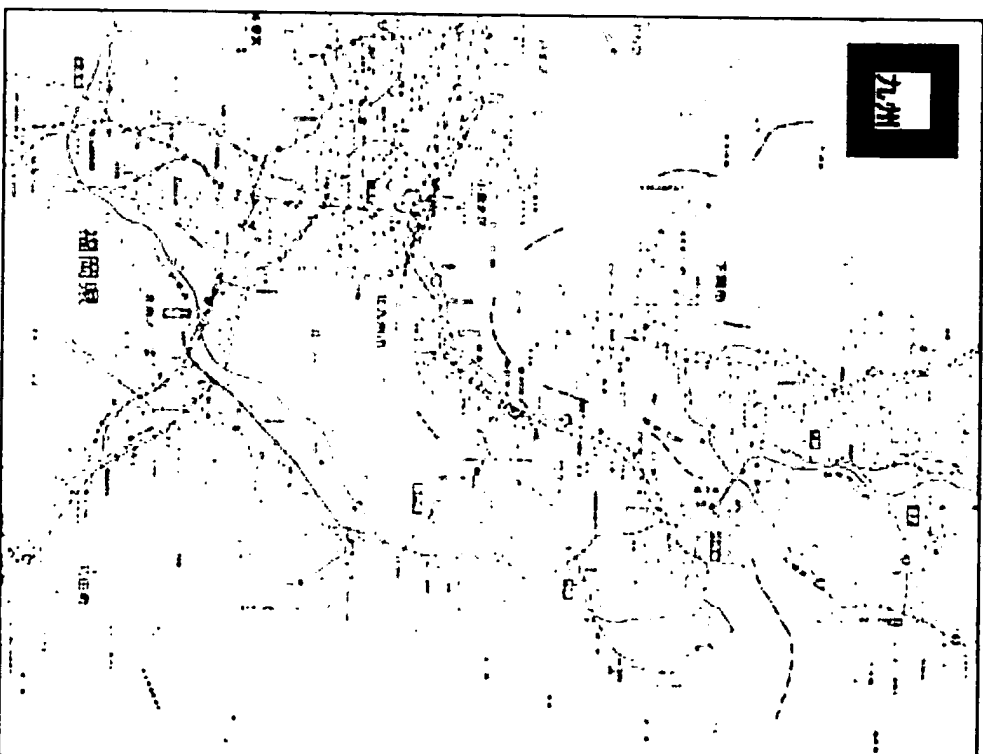
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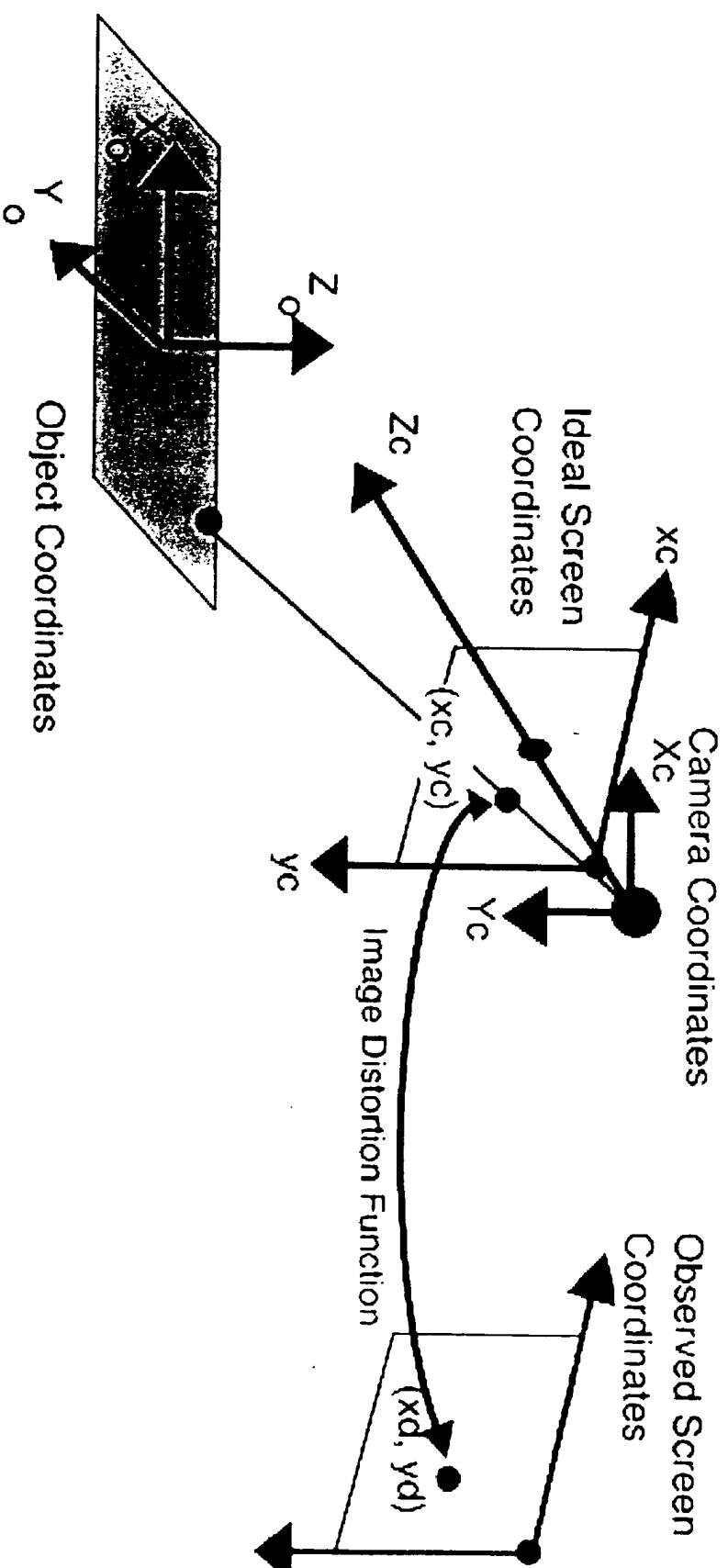


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FILE 12A



FILE 12B



$$F(u, v)$$

FIG 14A



FIG-14B



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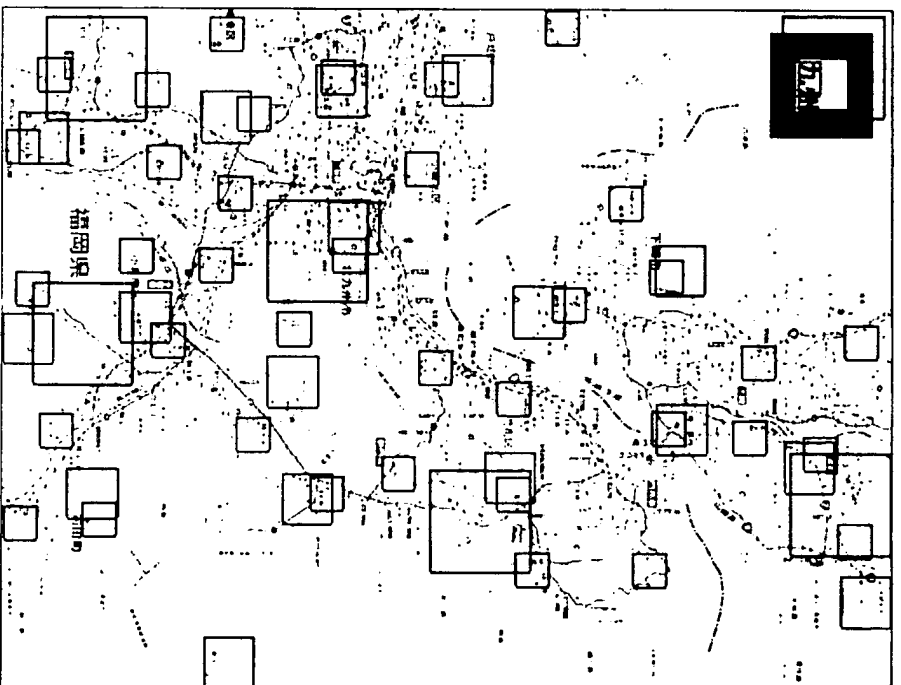
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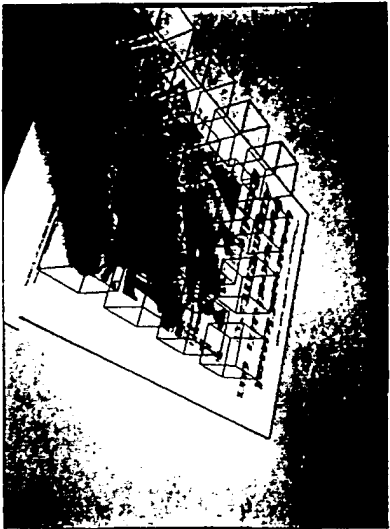


FIG 166-

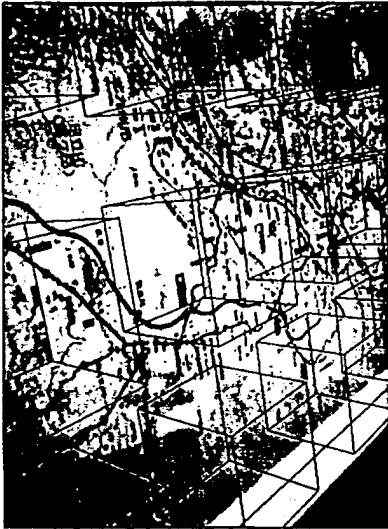


FIG 160

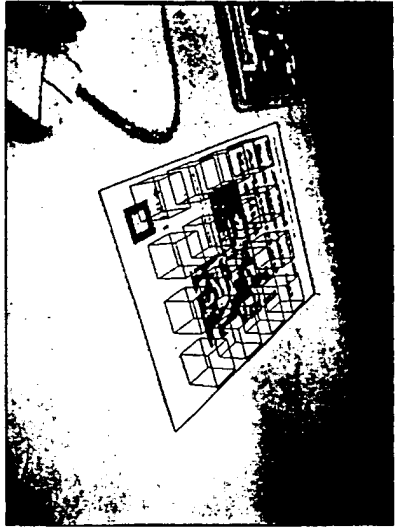


FIG 164



FIG 16E

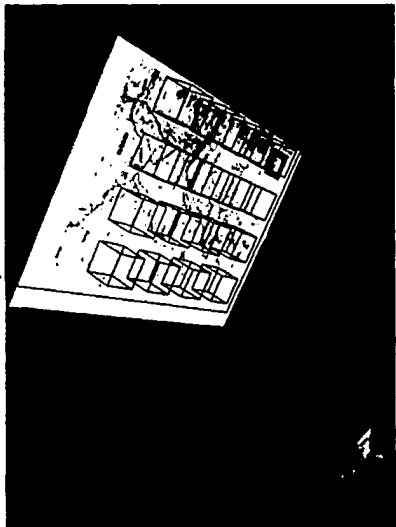


FIG 163



FIG 164



FIG 16F



FIG 16C



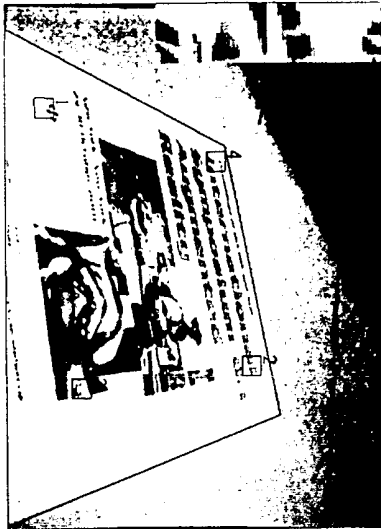


Fig 174



Fig 178

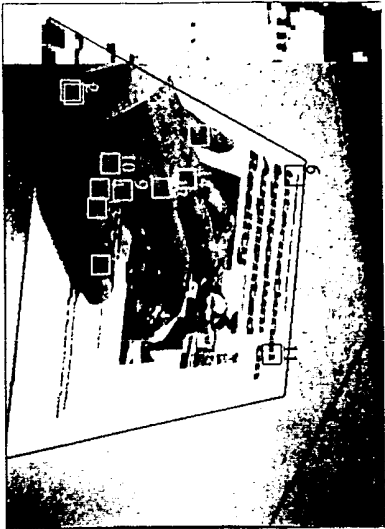


Fig 17c



Fig 17d